



Vincotech

B0-SL10NIB600S702-PA29F78Z**B0-SL10NIC600S702-PA39F78Z**

datasheet

flowNPC S3 split**950 V / 600 A****Topology features**

- Kelvin Emitter for improved switching performance
- Temperature sensor
- Neutral Point Clamped Topology (I-Type)
- Split topology

Component features

- Low collector emitter saturation voltage
- High speed and smooth switching

Housing features

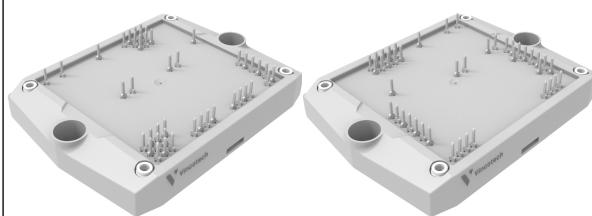
- Base isolation: AlN
- CTI600 housing material
- Compact, baseplate-less housing
- VINcoPress Technology
- Thermo-mechanical push-and-pull force relief
- Press-fit pin
- Reliable cold welding connection

Target applications

- Solar Inverters

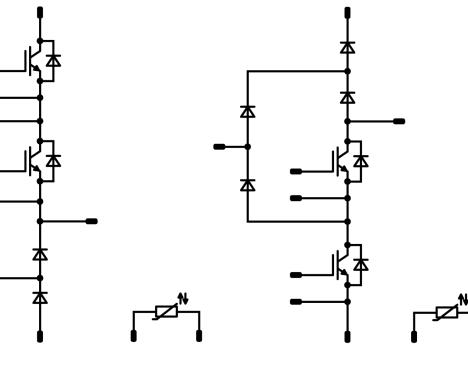
Types

- B0-SL10NIB600S702-PA29F78Z
- B0-SL10NIC600S702-PA39F78Z

flow S3 12 mm housing

PA29F78Z

PA39F78Z

Schematic

PA29F78Z

PA39F78Z



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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Buck Switch				
Collector-emitter voltage	V_{CES}		950	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	444	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	1200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	864	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Buck Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	171	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	728	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 25^\circ\text{C}$	1040	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	432	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Buck Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		950	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	77	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	160	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Boost Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	528	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	1200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	981	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 800\text{ V}$ $T_j = 150^\circ\text{C}$	9,5	μs
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost Diode

Peak repetitive reverse voltage	V_{RRM}		950	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	209	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	600	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	413	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost Sw. Inv. Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	220	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	450	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	390	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Boost Sw. Protection Diode				
Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	40	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10 \text{ ms}$	170	A
Surge current capability	P_t	$T_j = 150^\circ\text{C}$	145	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	113	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost D. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		950	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	77	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	160	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Module Properties

Thermal Properties				
Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2 \text{ s}$	6000	V
Creepage distance		B0-SL10NIB600S702-PA29F78Z B0-SL10NIC600S702-PA39F78Z	>12,7 9,93	mm
Clearance		B0-SL10NIB600S702-PA29F78Z B0-SL10NIC600S702-PA39F78Z	11,58 8,06	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	

Buck Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00975	25	4,35	5,1	5,85	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		600	25 125 150		1,82 2,07 2,13	2,25 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	950		25			12	µA
Gate-emitter leakage current	I_{GES}		20	0		25			300	nA
Internal gate resistance	r_g							0,5		Ω
Input capacitance	C_{res}	$f = 100$ kHz	0	25	25	25	37800	810	120	pF
Output capacitance	C_{oes}									
Reverse transfer capacitance	C_{res}									
Gate charge	Q_g		±15		0	25		1350		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,11		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 2 \Omega$ $R_{goff} = 4 \Omega$	±15	600	355	25		211,78	ns
Rise time	t_r					125		215,26	
Turn-off delay time	$t_{d(off)}$					150		216,47	
Fall time	t_f					25		34,5	ns
Turn-on energy (per pulse)	E_{on}					125		37,3	
Turn-off energy (per pulse)	E_{off}					150		37,75	
						25		270,24	
						125		311,24	ns
						150		321,97	
						25		29,46	ns
						125		45,96	
						150		56,5	
						25		9,16	mWs
						125		10,02	
						150		9,98	
						25		11,55	mWs
						125		17,35	
						150		19,23	



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Buck Diode

Static

Forward voltage	V_F				160	25 125 150		1,72 2,17 2,32	1,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V			25		280	1600	μ A	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,22		K/W
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Dynamic

Peak recovery current	I_{RM}	$di/dt=9122$ A/ μ s $di/dt=6238$ A/ μ s $di/dt=6469$ A/ μ s	± 15	600	355	25		61,78				
Reverse recovery time	t_{rr}					125		62,06				
Recovered charge	Q_r					150		62,93				
Reverse recovered energy	E_{rec}		± 15			25		22,52				
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		22,77				
						150		23,05		ns		
			± 15			25		0,835				
						125		0,851		μ C		
						150		0,855				
			± 15			25		0,26				
						125		0,263		mWs		
						150		0,266				
			± 15			25		6756,77				
						125		7049,49				
						150		6408,11		A/ μ s		



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Buck Sw. Protection Diode

Static

Forward voltage	V_F				100	25 125 150	2,1	2,64 2,44 2,36	2,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 950$ V			25				4	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,59		K/W
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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(\text{th})}$			10	0,06	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$		15		600	25 125 150		1,69 1,88 1,93	1,85 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			300	μA
Gate-emitter leakage current	I_{GES}		20	0		25			1500	nA
Internal gate resistance	r_g						0,667			Ω
Input capacitance	C_{res}		0	10	25		111000			pF
Output capacitance	C_{oes}						3300			pF
Reverse transfer capacitance	C_{res}						1260			pF
Gate charge	Q_g	$V_{CC} = 600$ V	0/15		600	25		3600		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 5,2$ W/mK (PTM)						0,1		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$	± 15	600	600	25		579,15		
Rise time	t_r					125		583,32		
						150		587		ns
Turn-off delay time	$t_{d(off)}$					25		159,66		
						125		178,99		
Fall time	t_f					150		185,61		ns
Turn-on energy (per pulse)	E_{on}	$Q_{fFWD}=5$ μC $Q_{rfFWD}=14,99$ μC $Q_{ffFWD}=18,2$ μC				25		356,71		
Turn-off energy (per pulse)	E_{off}					125		389,7		
						150		401,8		ns
						25		76,99		
						125		97,68		
						150		103,24		ns
						25		69,98		
						125		89,22		mWs
						150		95,96		
						25		39,36		
						125		49,08		mWs
						150		51,32		



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Boost Diode

Static

Forward voltage	V_F				300	25 125 150	2,1	2,59 2,43 2,37	2,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 950$ V			25			12	μ A	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,23		K/W
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Dynamic

Peak recovery current	I_{RM}	$di/dt=2823$ A/ μ s $di/dt=2590$ A/ μ s $di/dt=2276$ A/ μ s	± 15	600	600	25		65,6		
Reverse recovery time	t_{rr}					125		113,82		
Recovered charge	Q_r					150		120,13		A
Recovered charge	Q_r		± 15	600	600	25		169,26		
Reverse recovered energy	E_{rec}					125		278,24		ns
Reverse recovered energy	E_{rec}					150		317,94		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		± 15	600	600	25		5		μ C
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		14,99		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		18,2		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		± 15	600	600	25		1,12		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		3,78		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		4,67		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		± 15	600	600	25		722,67		A/μ s
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		604,7		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		472,81		



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Boost Sw. Inv. Diode

Static

Forward voltage	V_F				225	25 125 150	1,45	1,9 1,83 1,8	1,95 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V			25				2,28	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,24		K/W
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Boost Sw. Protection Diode

Static

Forward voltage	V_F				35	25 125 150		2,53 2,67 2,58	2,62 ⁽¹⁾ 2,62 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V				25 150			60 2700	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,84		K/W
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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Boost D. Protection Diode

Static

Forward voltage	V_F				100	25 125 150	2,1	2,64 2,44 2,36	2,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_F = 950$ V			25			4	μA	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,59		K/W
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Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R100	$A_{R/R}$	$R_{100} = 1484$ Ω				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference								I		

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



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Buck Switch Characteristics

figure 1. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

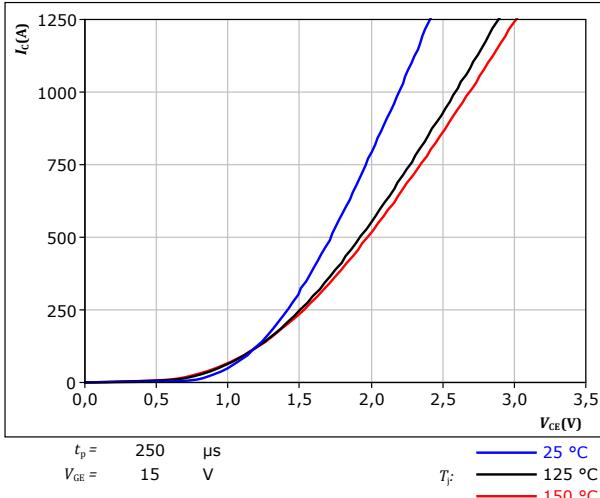


figure 2. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

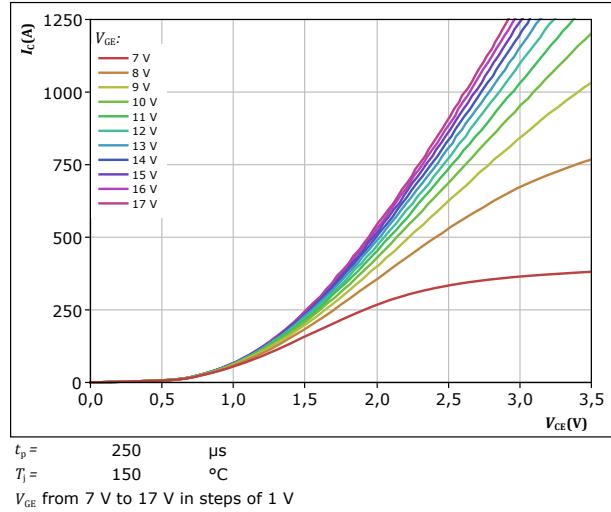


figure 3. IGBT

Typical transfer characteristics
 $I_C = f(V_{GE})$

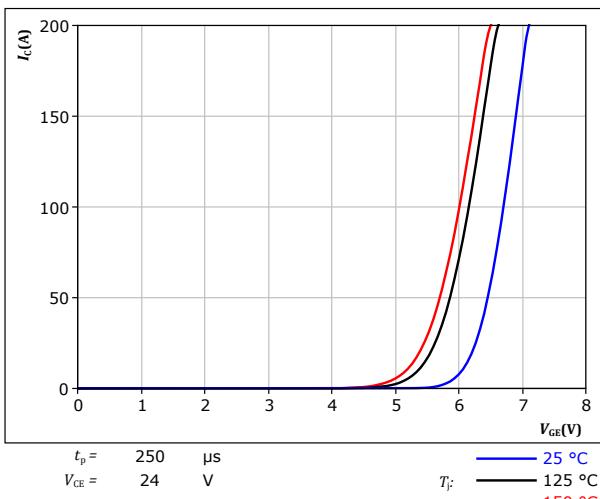
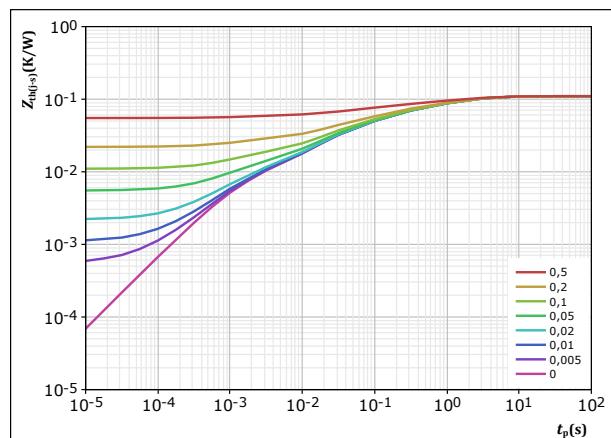


figure 4. IGBT

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$

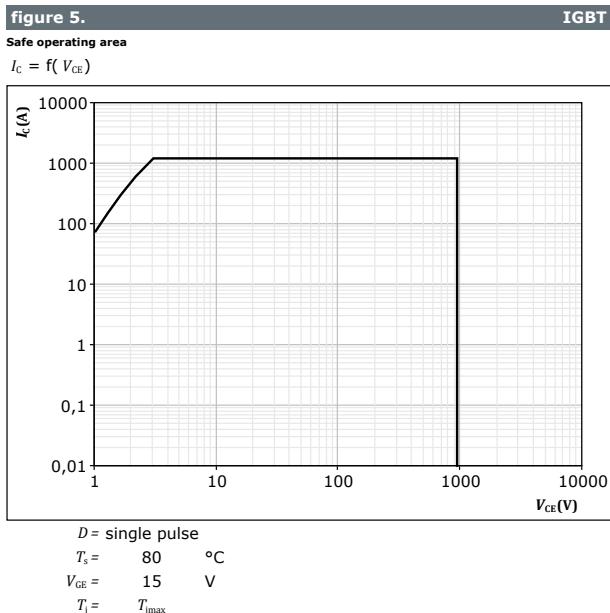




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Buck Switch Characteristics





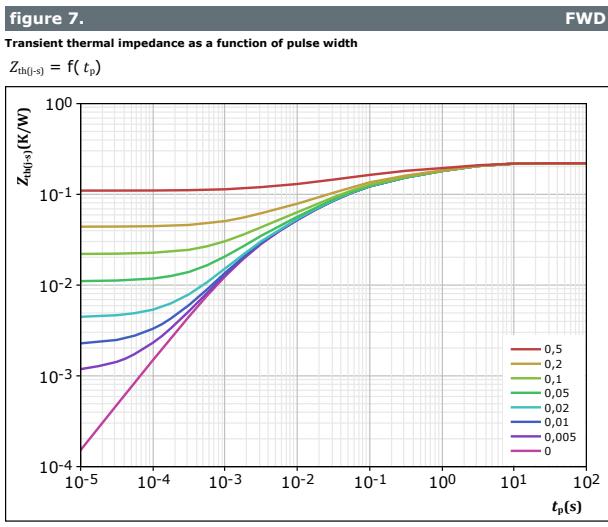
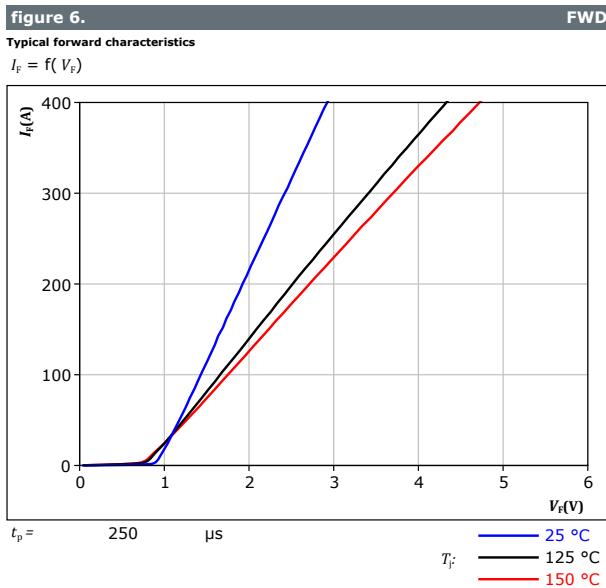
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Buck Diode Characteristics





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Buck Sw. Protection Diode Characteristics

figure 8.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD

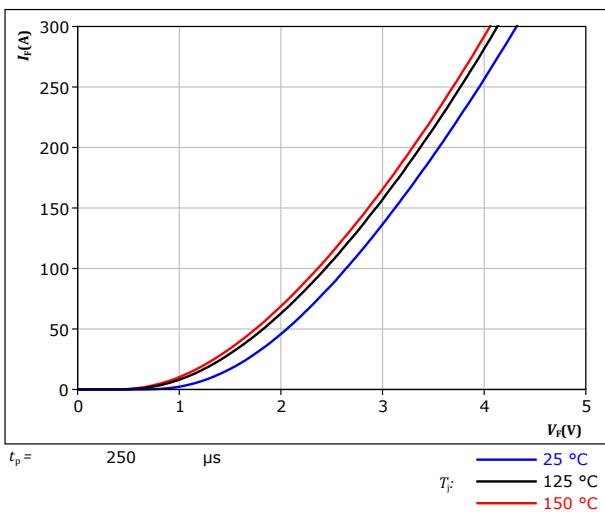
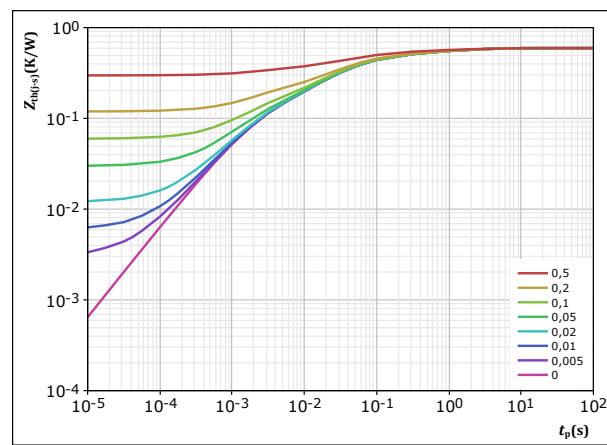


figure 9.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{0,594} \quad K/W$$

FWD thermal model values

R (K/W)	τ (s)
5,02E-02	2,46E+00
7,95E-02	4,43E-01
2,28E-01	5,90E-02
1,50E-01	1,50E-02
8,75E-02	1,73E-03



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Boost Switch Characteristics

figure 10.

Typical output characteristics

$$I_C = f(V_{CE})$$

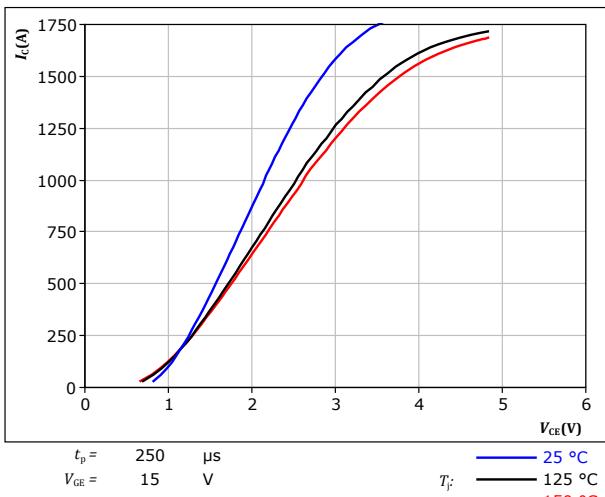


figure 12.

Typical transfer characteristics

$$I_C = f(V_{GE})$$

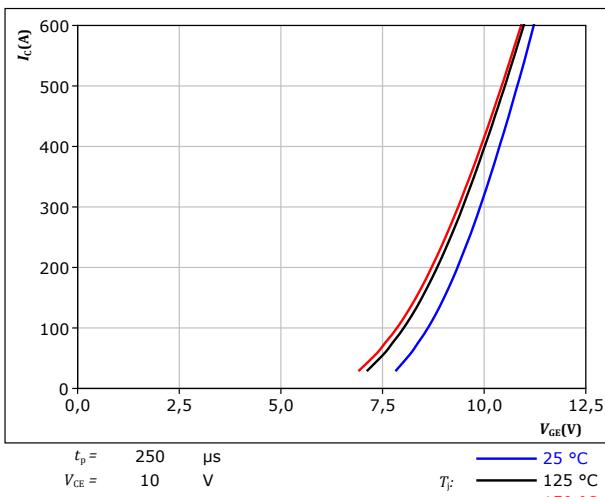


figure 11.

Typical output characteristics

$$I_C = f(V_{CE})$$

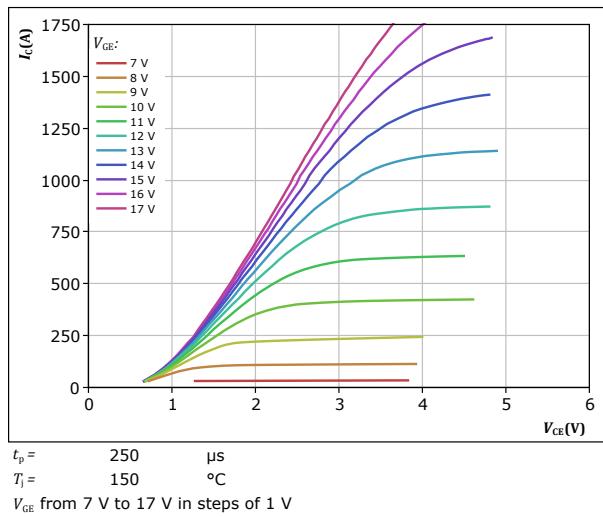
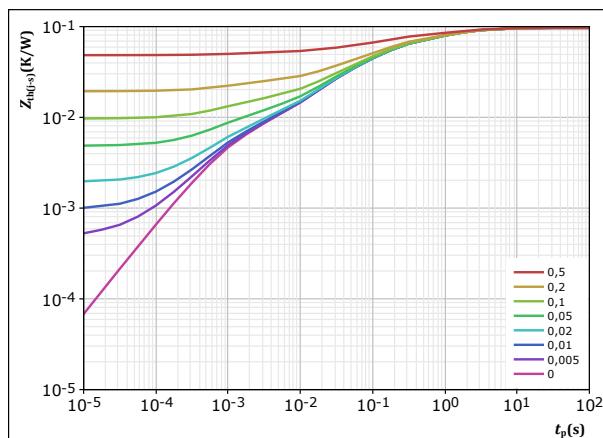


figure 13.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$$R_{th(j-s)} = \frac{t_p}{T} K/W$$

IGBT thermal model values

R (K/W)	τ (s)
1,01E-02	3,90E+00
2,69E-02	9,57E-01
3,87E-02	1,31E-01
1,54E-02	2,17E-02
5,74E-03	9,87E-04



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Boost Switch Characteristics

figure 14.

Safe operating area

$$I_C = f(V_{CE})$$

IGBT

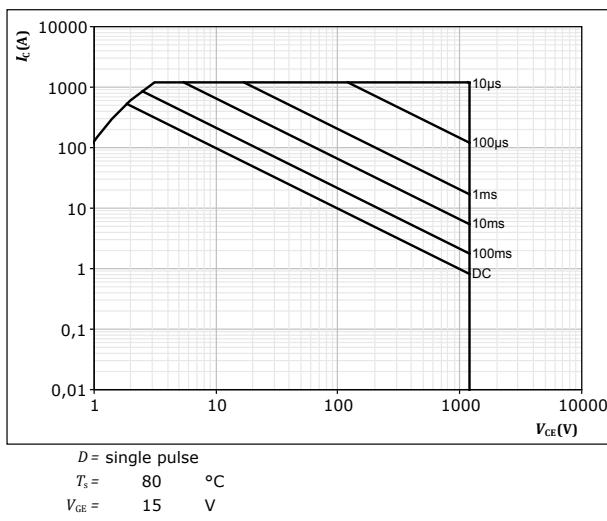
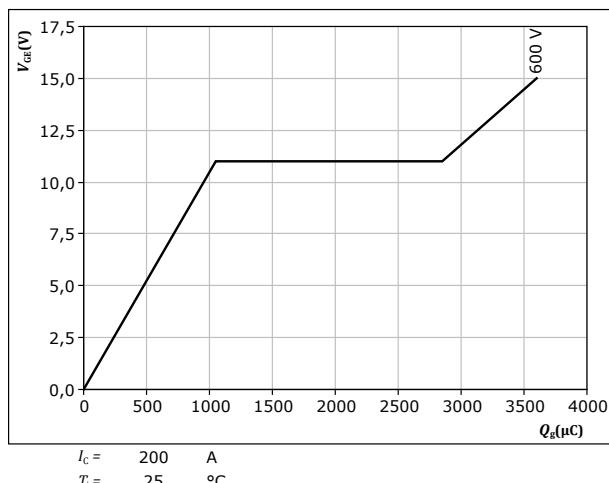


figure 15.

Gate voltage vs gate charge

$$V_{GE} = f(Q_g)$$

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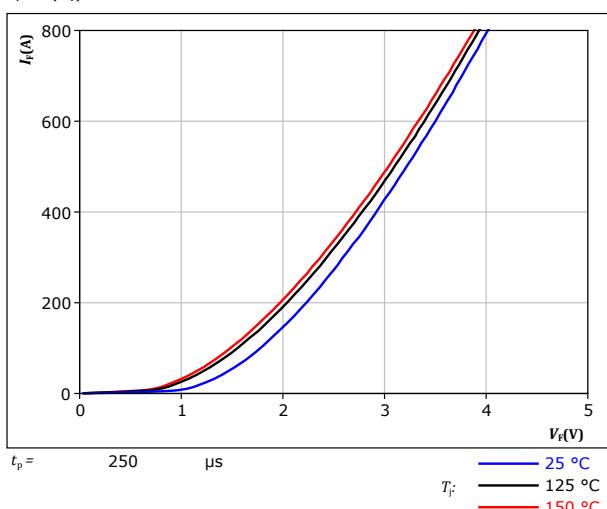
Boost Diode Characteristics

figure 16.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

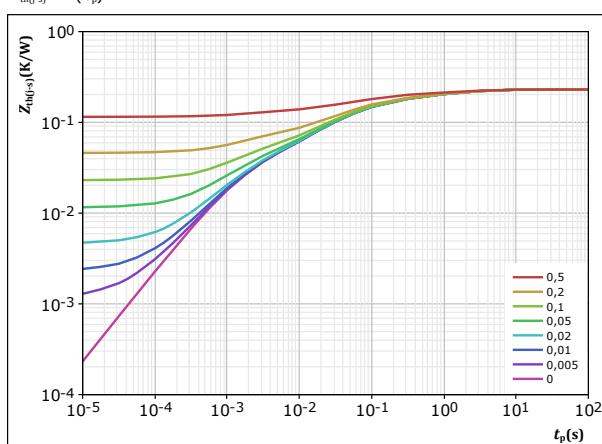
$$T_F: \begin{cases} 25^\circ\text{C} \\ 125^\circ\text{C} \\ 150^\circ\text{C} \end{cases}$$

figure 17.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,23 \quad \text{K/W}$$

FWD thermal model values

R (K/W)	τ (s)
2,56E-02	2,90E+00
4,35E-02	5,53E-01
9,09E-02	6,81E-02
4,34E-02	1,43E-02
2,66E-02	1,41E-03



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datasheet

Boost Sw. Inv. Diode Characteristics

figure 18.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD

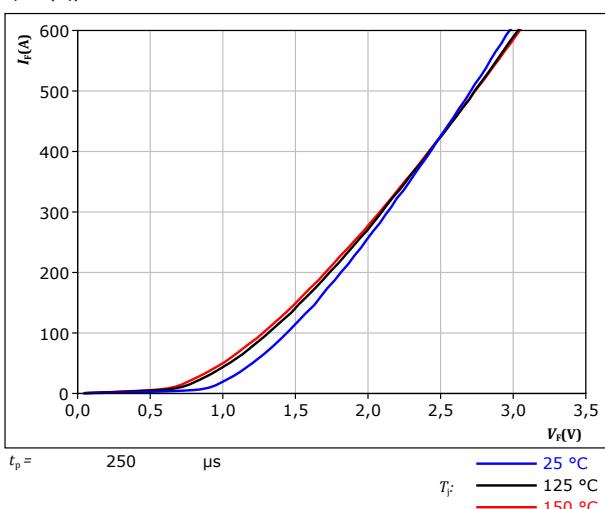
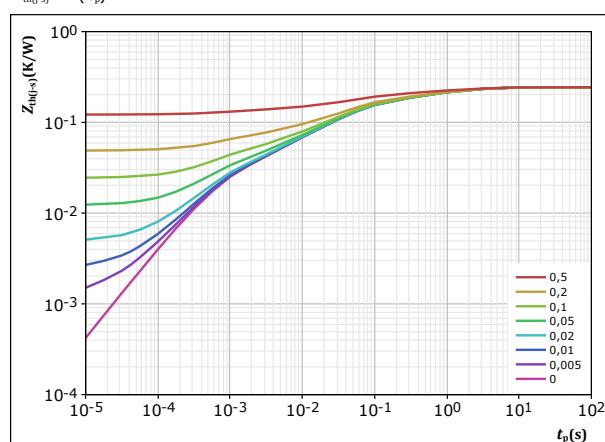


figure 19.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,244 \quad \text{K/W}$$

FWD thermal model values

R (K/W)	τ (s)
3,51E-02	2,48E+00
5,14E-02	4,38E-01
9,82E-02	5,01E-02
3,42E-02	7,68E-03
2,47E-02	6,90E-04



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datasheet

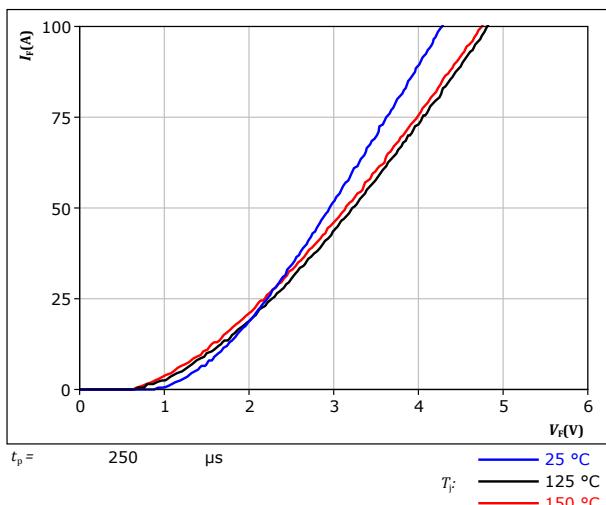
Boost Sw. Protection Diode Characteristics

figure 20.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

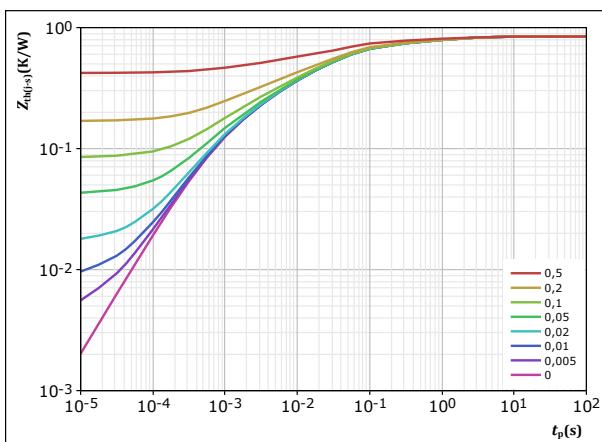
T_F :
— 25 °C
— 125 °C
— 150 °C

figure 21.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p}{T} = 0,843$$

K/W

FWD thermal model values

R (K/W)	τ (s)
9,03E-02	1,79E+00
1,29E-01	1,94E-01
3,56E-01	2,98E-02
1,83E-01	3,56E-03
8,48E-02	6,09E-04



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datasheet

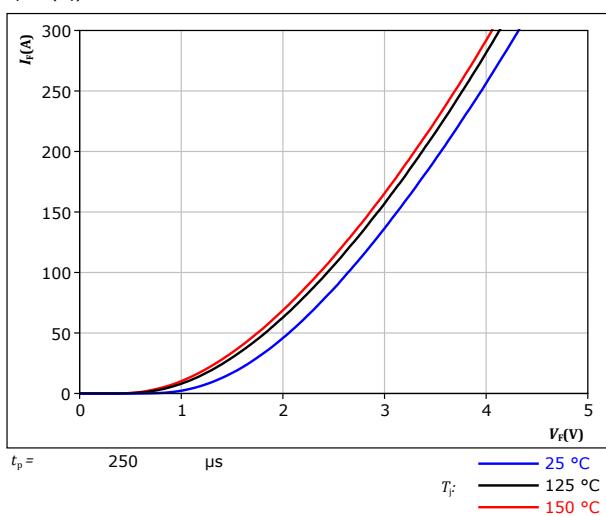
Boost D. Protection Diode Characteristics

figure 22.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

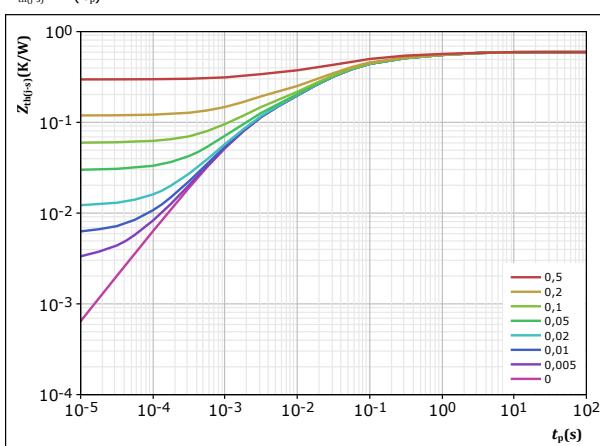
T_{J_F} :
— 25 °C
— 125 °C
— 150 °C

figure 23.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,594 \quad \text{K/W}$$

FWD thermal model values

R (K/W)	τ (s)
5,02E-02	2,46E+00
7,95E-02	4,43E-01
2,28E-01	5,90E-02
1,50E-01	1,50E-02
8,75E-02	1,73E-03



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datasheet

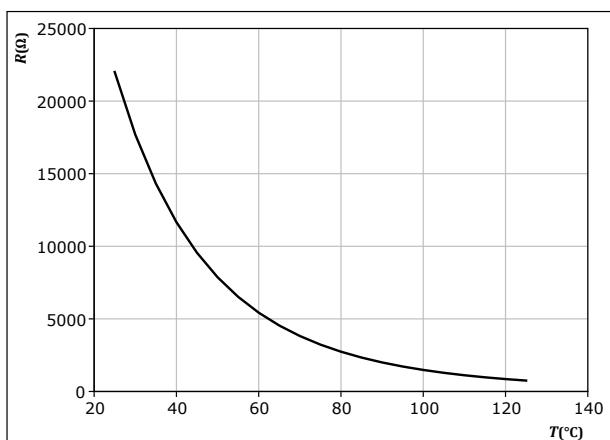
Thermistor Characteristics

figure 24.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





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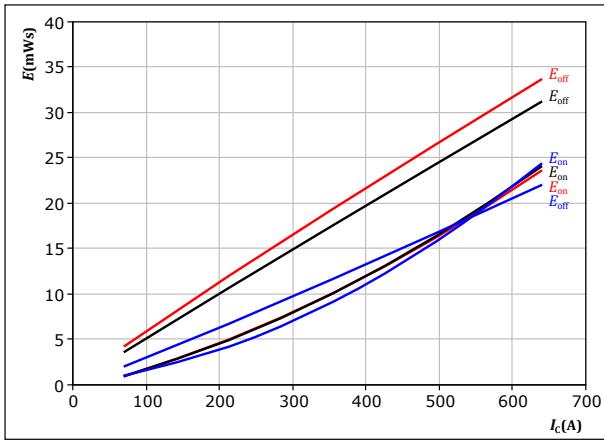
datasheet

Buck Switching Characteristics

figure 25.

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

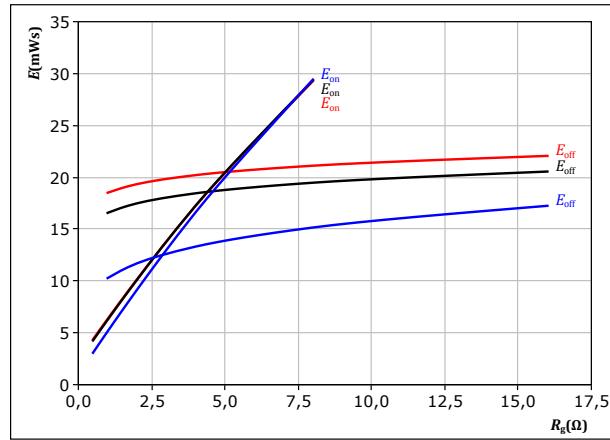
$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 2 \Omega \\ R_{goff} &= 4 \Omega \end{aligned}$$

IGBT

figure 26.

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

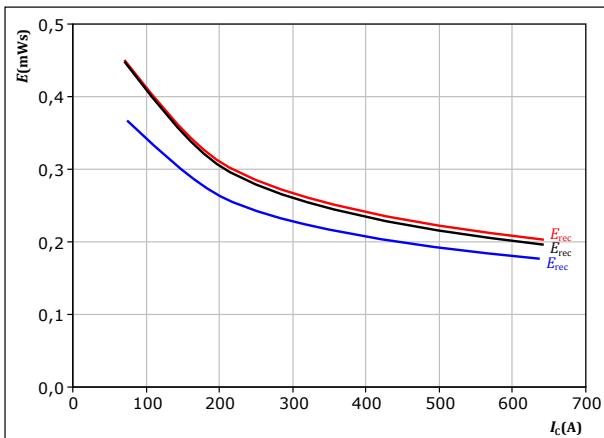
$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ I_c &= 355 \text{ A} \end{aligned}$$

IGBT

figure 27.

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

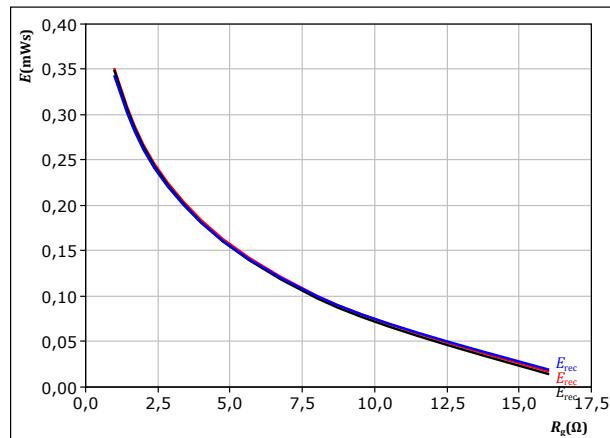
$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 2 \Omega \end{aligned}$$

FWD

figure 28.

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ I_c &= 355 \text{ A} \end{aligned}$$

FWD



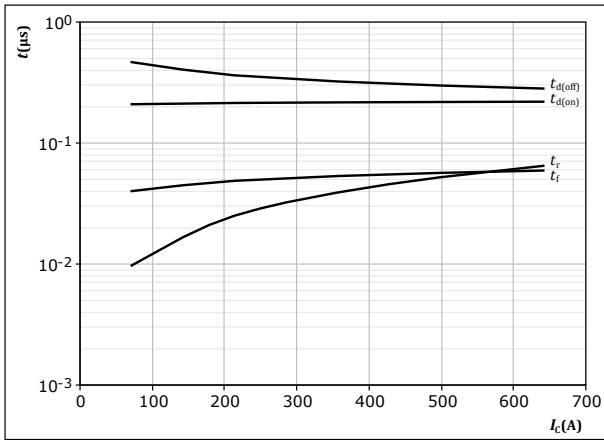
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 datasheet

Buck Switching Characteristics

figure 29.

Typical switching times as a function of collector current
 $t = f(I_C)$



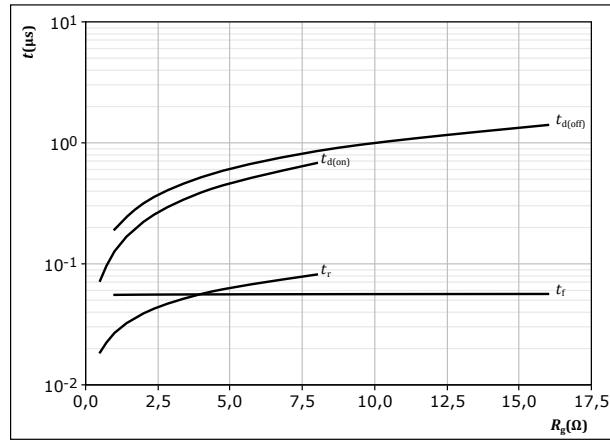
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \Omega$
 $R_{goff} = 4 \Omega$

IGBT

figure 30.

Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



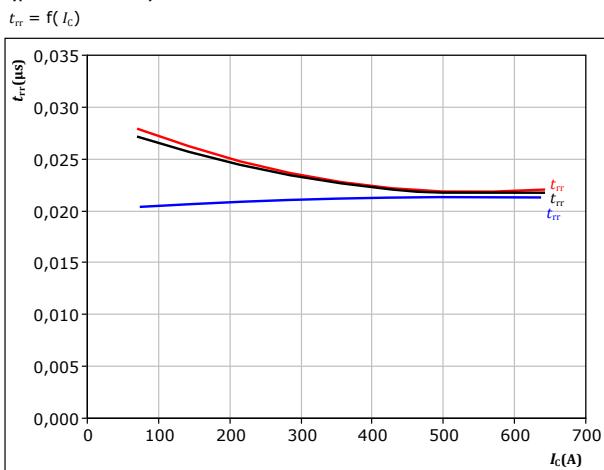
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 355 \text{ A}$

IGBT

figure 31.

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



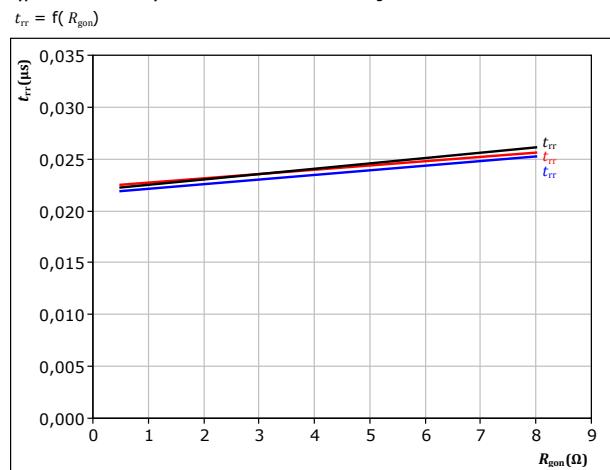
With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \Omega$

FWD

figure 32.

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 355 \text{ A}$

FWD



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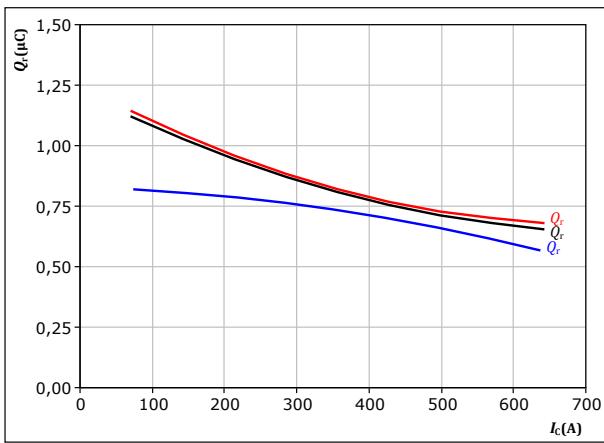
datasheet

Buck Switching Characteristics

figure 33.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

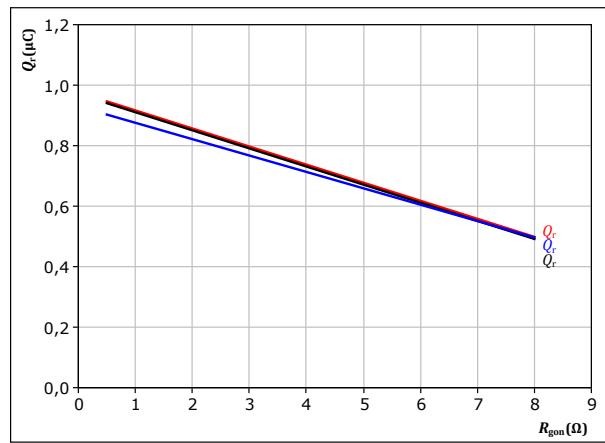
$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 2 \Omega & T_f &= 125 \text{ }^{\circ}\text{C} \\ & & & \\ & & & T_f = 150 \text{ }^{\circ}\text{C} \end{aligned}$$

FWD

figure 34.

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



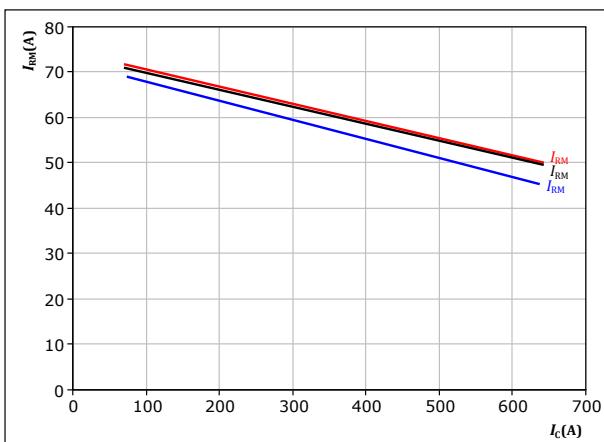
With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 355 \text{ A} & T_f &= 125 \text{ }^{\circ}\text{C} \\ & & & \\ & & & T_f = 150 \text{ }^{\circ}\text{C} \end{aligned}$$

figure 35.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

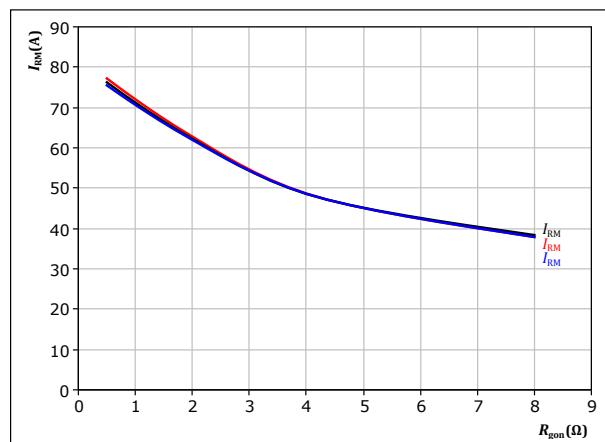
$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 2 \Omega & T_f &= 125 \text{ }^{\circ}\text{C} \\ & & & \\ & & & T_f = 150 \text{ }^{\circ}\text{C} \end{aligned}$$

FWD

figure 36.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 355 \text{ A} & T_f &= 125 \text{ }^{\circ}\text{C} \\ & & & \\ & & & T_f = 150 \text{ }^{\circ}\text{C} \end{aligned}$$



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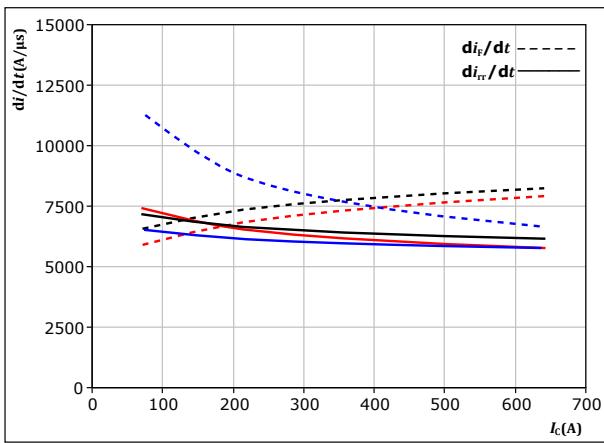
datasheet

Buck Switching Characteristics

figure 37.

FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



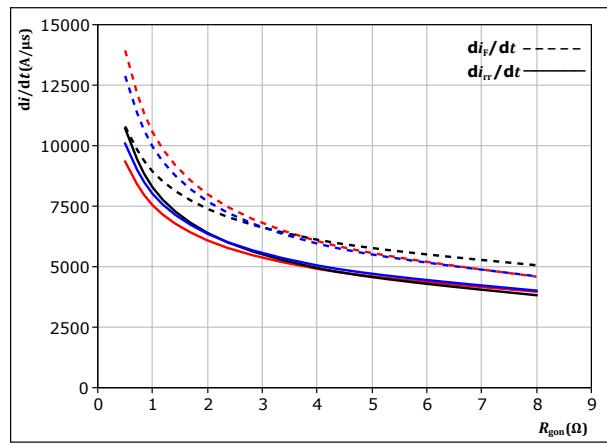
With an inductive load at

$V_{CE} =$	600	V	$T_j =$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{gon} =$	2	Ω		150 °C

figure 38.

FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at

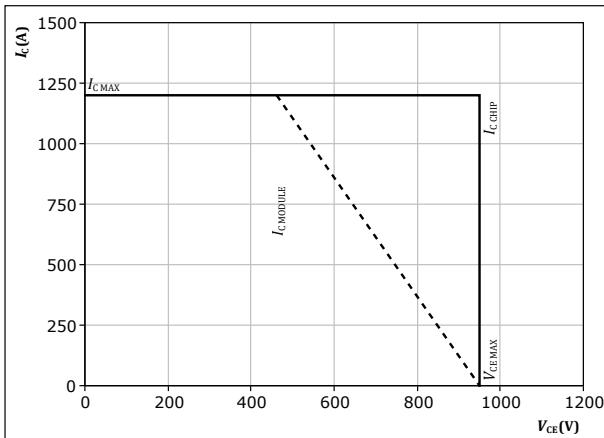
$V_{CE} =$	600	V	$T_j =$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_c =$	355	A		150 °C

figure 39.

IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150$ °C

$R_{gon} =$	2	Ω
$R_{goff} =$	4	Ω



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datasheet

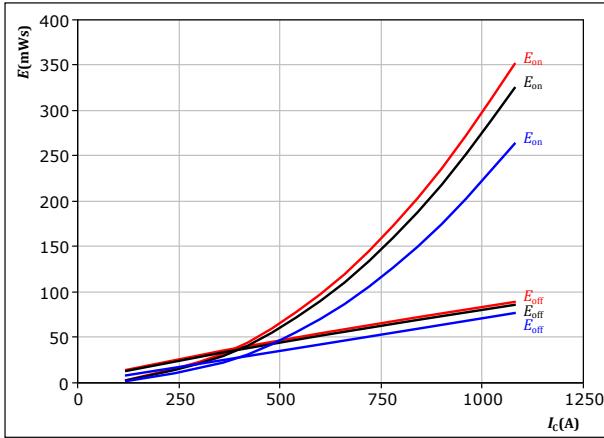
Boost Switching Characteristics

figure 40.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

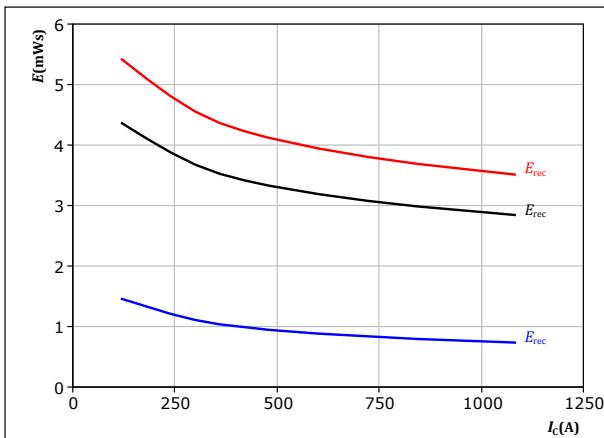
$V_{CE} =$	600	V	$T_f =$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{gon} =$	2	Ω		150 °C
$R_{goff} =$	2	Ω		

figure 42.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

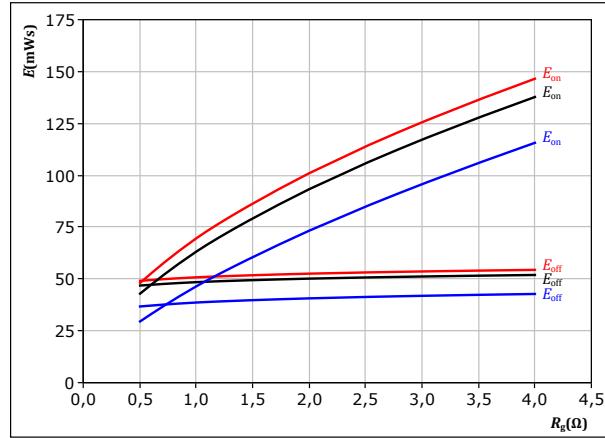
$V_{CE} =$	600	V	$T_f =$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{gon} =$	2	Ω		150 °C

figure 41.

IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

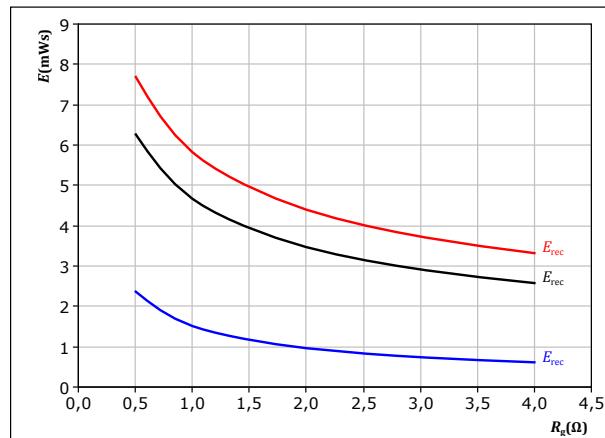
$V_{CE} =$	600	V	$T_f =$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_c =$	600	A		150 °C

figure 43.

FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} =$	600	V	$T_f =$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_c =$	600	A		150 °C



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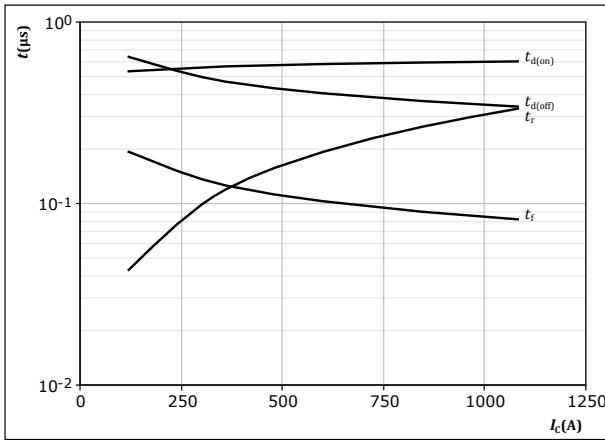
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datasheet

Boost Switching Characteristics

figure 44.

Typical switching times as a function of collector current
 $t = f(I_C)$



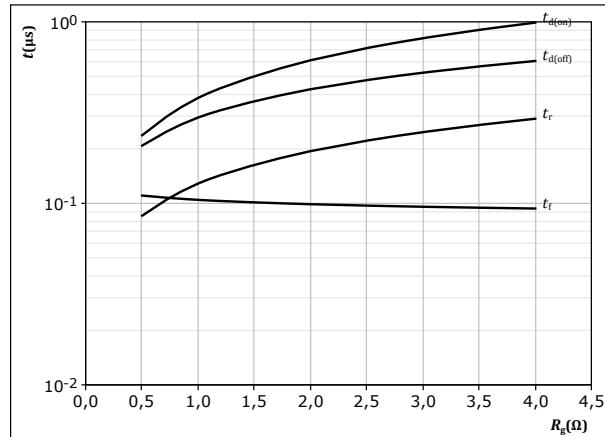
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \Omega$
 $R_{goff} = 2 \Omega$

IGBT

figure 45.

Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



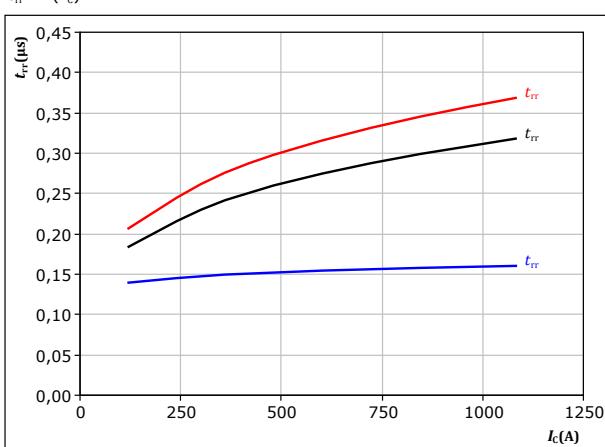
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 600 \text{ A}$

IGBT

figure 46.

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



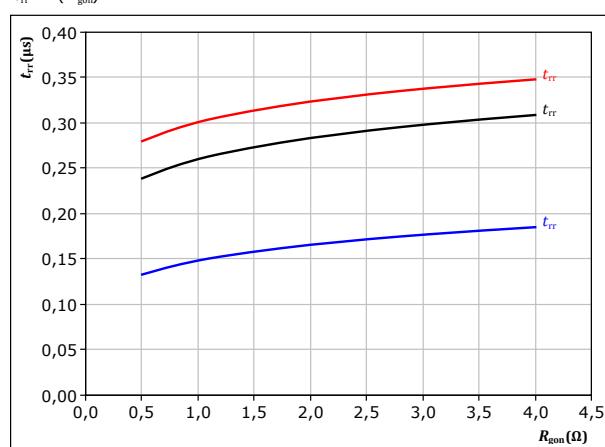
With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \Omega$

FWD

figure 47.

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 600 \text{ A}$

FWD



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BO-SL10NIC600S702-PA39F78Z

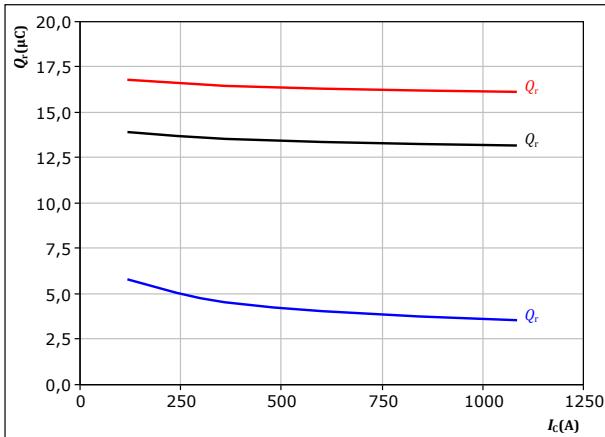
datasheet

Boost Switching Characteristics

figure 48.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

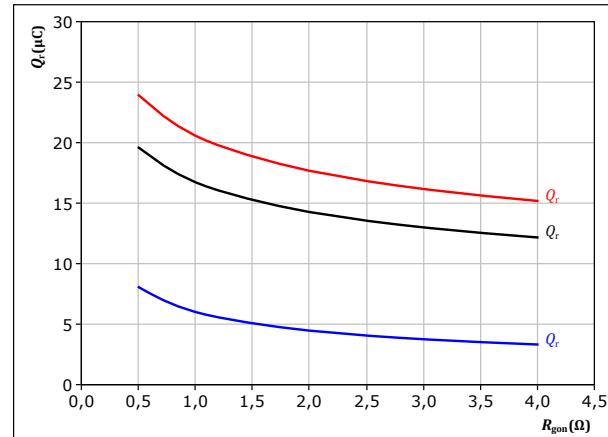
$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 2 \quad \Omega \end{aligned}$$

FWD

figure 49.

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



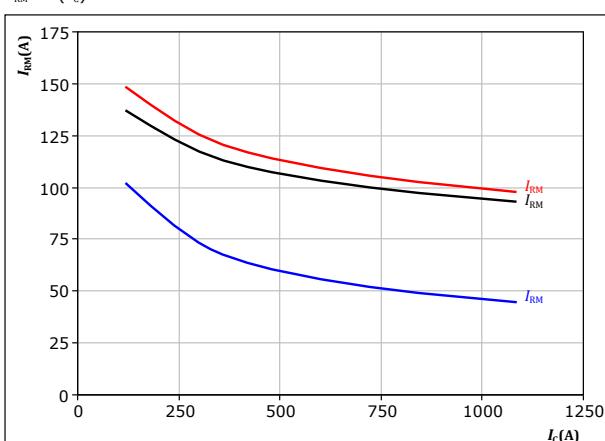
With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_c &= 600 \quad \text{A} \end{aligned}$$

figure 50.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

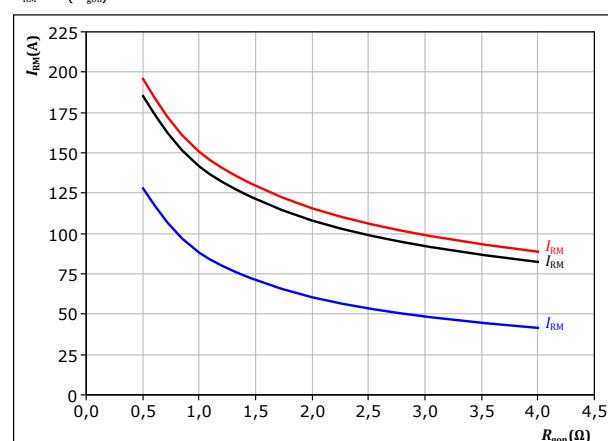
$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 2 \quad \Omega \end{aligned}$$

FWD

figure 51.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_c &= 600 \quad \text{A} \end{aligned}$$



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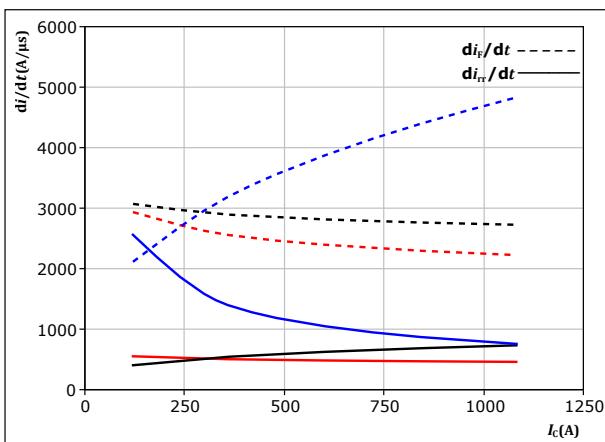
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Boost Switching Characteristics

figure 52.

FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



With an inductive load at

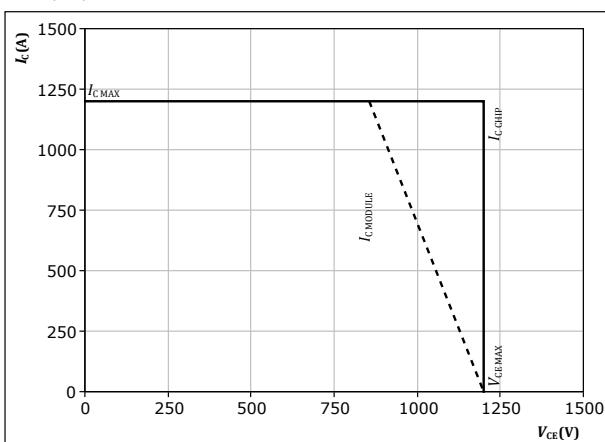
$V_{CE} = 600$ V $T_j = 25$ °C
 $V_{GE} = \pm 15$ V $T_j = 125$ °C
 $R_{gon} = 2$ Ω $T_j = 150$ °C

figure 54.

IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



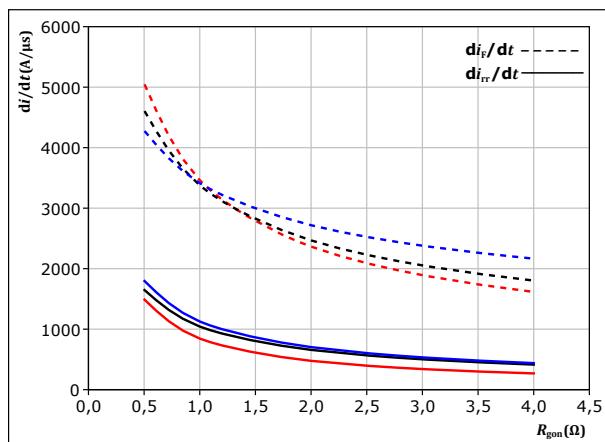
At $T_j = 150$ °C

$R_{gon} = 2$ Ω
 $R_{goff} = 2$ Ω

figure 53.

FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at

$V_{CE} = 600$ V $T_j = 25$ °C
 $V_{GE} = \pm 15$ V $T_j = 125$ °C
 $I_c = 600$ A $T_j = 150$ °C



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Switching Definitions

figure 55. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

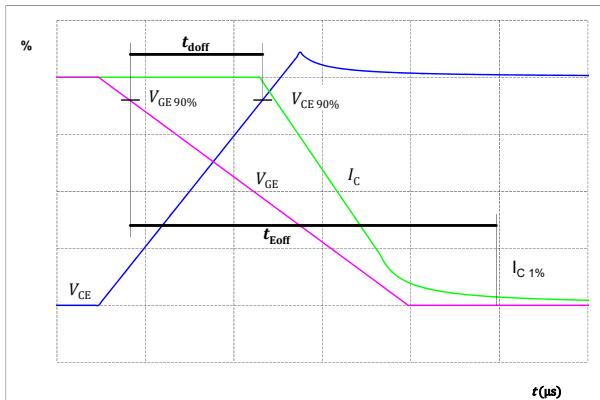


figure 56. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

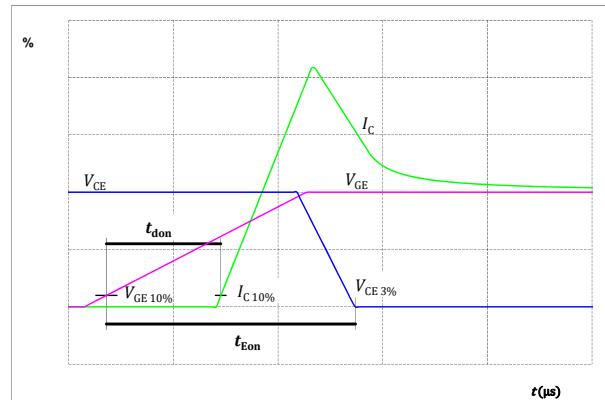


figure 57. IGBT

Turn-off Switching Waveforms & definition of t_f

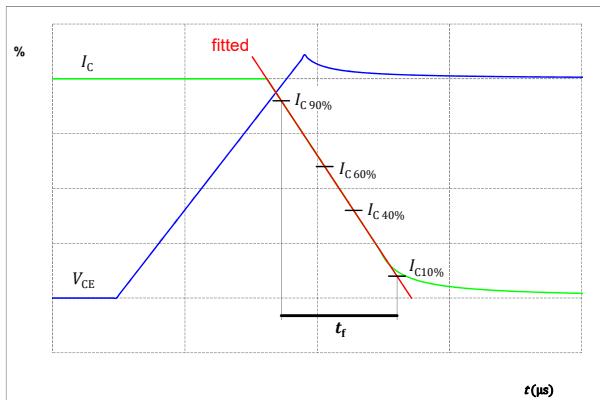
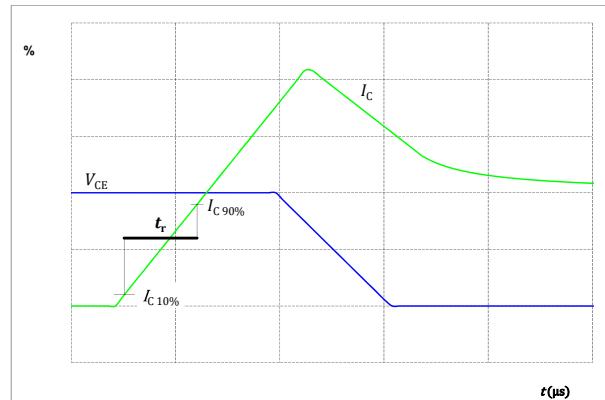


figure 58. IGBT

Turn-on Switching Waveforms & definition of t_r





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Switching Definitions

figure 59.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

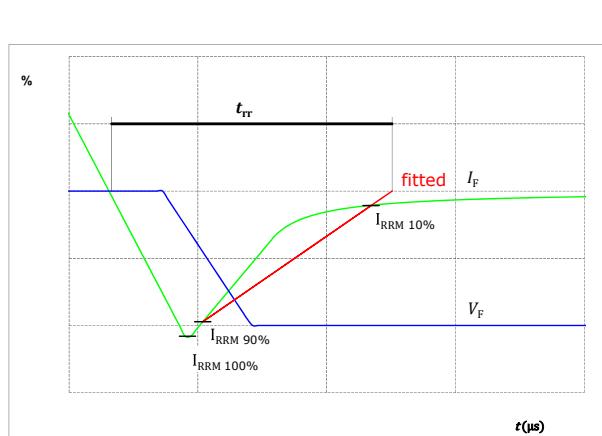
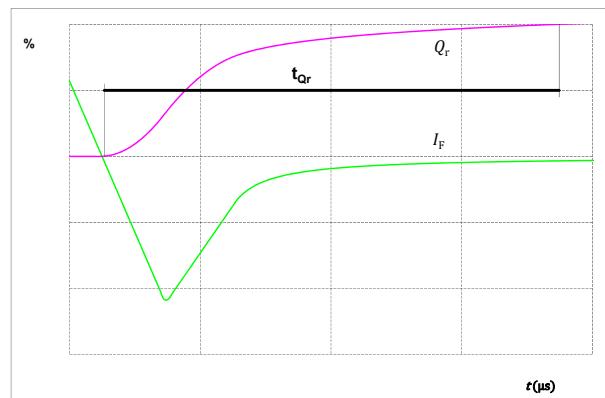


figure 60.

Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)

FWD





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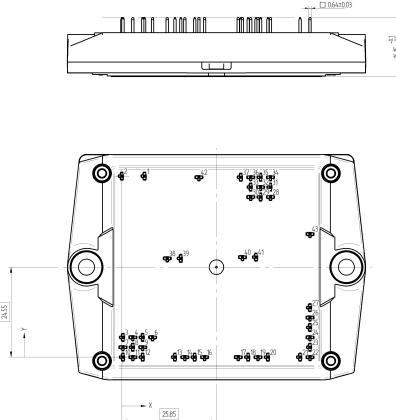
Ordering Code	
Version	Ordering Code
Without thermal paste	BO-SL10NIB600S702-PA29F78Z
With thermal paste (5,2 W/mK, PTM6000HV)	BO-SL10NIB600S702-PA29F78Z/-7/

Marking						
Text	Name	Date code	UL & VIN	Lot	Serial	
	NN-NNNNNNNNNNNN TTTTTTVVVWYY JL VIN LLLL SSSS	WWYY	UL VIN	LLLLL	SSSS	
Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTVVV	LLLLL	SSSS	WWYY		

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Outline

Pin table [mm]			
Pin	X	Y	Function
1	6,2	49,4	Therm1
2	0	49,4	Therm2
3	0,3	5,4	DC+
4	3	5,4	DC+
5	5,7	5,4	DC+
6	8,4	5,4	DC+
7	0,3	2,7	DC+
8	3	2,7	DC+
9	5,7	2,7	DC+
10	0,3	0	DC+
11	3	0	DC+
12	5,7	0	DC+
13	14,5	0	GND
14	17,2	0	GND
15	19,9	0	GND
16	22,6	0	GND
17	31,8	0	GND
18	34,5	0	GND
19	37,2	0	GND
20	39,9	0	GND
21	48,7	0	DC-
22	51,4	0	DC-
23	51,4	2,7	DC-
24	51,4	5,4	DC-
25	51,4	8,1	DC-
26	51,4	10,8	DC-
27	51,4	13,5	DC-
28	40,6	43,7	Ph
29	37,9	43,7	Ph
30	35,2	43,7	Ph
31	40,6	46,4	Ph
32	37,9	46,4	Ph
33	35,2	46,4	Ph
34	40,6	49,1	Ph
35	37,9	49,1	Ph
36	35,2	49,1	Ph
37	32,5	49,1	Ph
38	12,4	26,95	G11
39	16,1	26,95	S11
40	32,95	27,3	G13
41	36,65	27,3	S13
42	21,05	49,1	TM1
43	51,4	33,6	TM2



Tolerance of dimension: ±0.05 mm of the set of pins.
Dimension of coordinate axis is only valid without tolerance.



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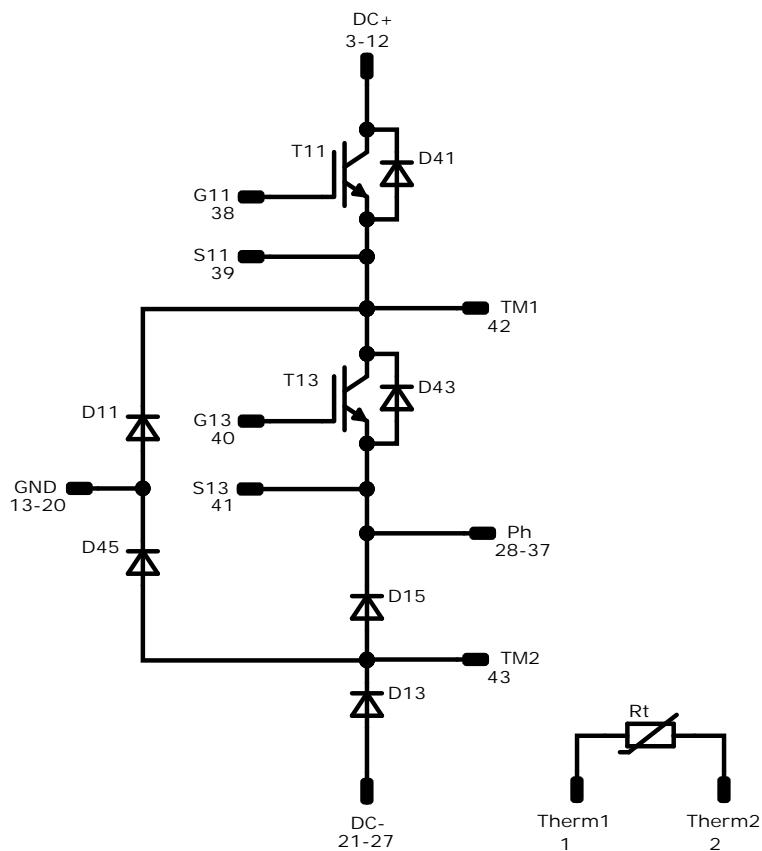
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Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T11	IGBT	950 V	600 A	Buck Switch	
D11	FWD	1200 V	160 A	Buck Diode	
D41	FWD	950 V	100 A	Buck Sw. Protection Diode	
T13	IGBT	1200 V	600 A	Boost Switch	
D13	FWD	950 V	300 A	Boost Diode	
D15	FWD	1200 V	225 A	Boost Sw. Inv. Diode	
D43	FWD	1200 V	35 A	Boost Sw. Protection Diode	
D45	FWD	950 V	100 A	Boost D. Protection Diode	
Rt	Thermistor			Thermistor	



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datasheet

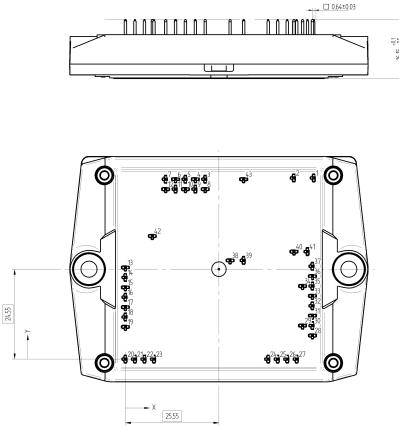
Ordering Code	
Version	Ordering Code
Without thermal paste	B0-SL10NIC600S702-PA39F78Z
With thermal paste (5,2 W/mK, PTM6000HV)	B0-SL10NIC600S702-PA39F78Z-/7/

Marking						
Text	Name		Date code	UL & VIN	Lot	Serial
	NN-NNNNNNNNNNNNNN	VIN LLLL SSSS	WWYY	UL VIN	LLLLL	SSSS
Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTVV	LLLLL	SSSS	WWYY		

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Outline

Pin table [mm]			
Pin	X	Y	Function
1	51,45	49,45	Therm1
2	46	49,45	Therm2
3	21,8	49,1	Ph
4	19,1	49,1	Ph
5	16,4	49,1	Ph
6	13,7	49,1	Ph
7	11	49,1	Ph
8	21,8	46,4	Ph
9	19,1	46,4	Ph
10	16,4	46,4	Ph
11	13,7	46,4	Ph
12	11	46,4	Ph
13	0	25	DC+
14	0	22,3	DC+
15	0	19,6	DC+
16	0	16,9	DC+
17	0	14,2	DC+
18	0	11,5	DC+
19	0	8,8	DC+
20	0	0	GND
21	2,6	0	GND
22	5,2	0	GND
23	7,8	0	GND
24	39	0	GND
25	41,6	0	GND
26	44,2	0	GND
27	46,8	0	GND
28	51,1	6,45	DC-
29	48,4	9,15	DC-
30	51,1	9,15	DC-
31	51,1	11,85	DC-
32	51,1	14,55	DC-
33	51,1	17,25	DC-
34	48,4	19,95	DC-
35	51,1	19,95	DC-
36	51,1	22,65	DC-
37	51,1	25,35	DC-
38	28,6	26,95	G14
39	32,3	26,95	S14
40	46,05	29,35	G12
41	49,75	29,35	S12
42	7,35	33,6	TM3
43	32,3	49,1	TM4



Dimensions or proportions: ±0.05 mm of the overall size
Dimension of coordinate axis is only valid without tolerance.



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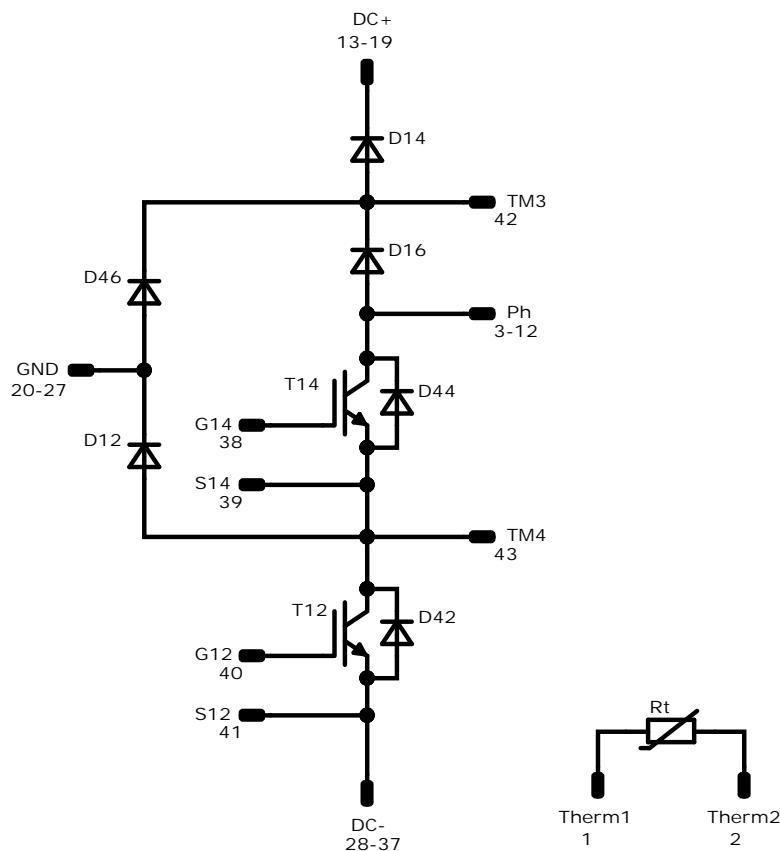
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datasheet

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Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T12	IGBT	950 V	600 A	Buck Switch	
D12	FWD	1200 V	160 A	Buck Diode	
D42	FWD	950 V	100 A	Buck Sw. Protection Diode	
T14	IGBT	1200 V	600 A	Boost Switch	
D14	FWD	950 V	300 A	Boost Diode	
D16	FWD	1200 V	225 A	Boost Sw. Inv. Diode	
D44	FWD	1200 V	35 A	Boost Sw. Protection Diode	
D46	FWD	950 V	100 A	Boost D. Protection Diode	
R _t	Thermistor			Thermistor	



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datasheet

Packaging instruction

Standard packaging quantity (SPQ) 45	>SPQ	Standard	<SPQ	Sample
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Handling instruction

Handling instructions for flow S3 packages see vincotech.com website.

Package data

Package data for flow S3 packages see vincotech.com website.

Vincotech thermistor reference

See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
BO-SL10NIx600S702-PAx9F78Z-D4-14	15 Dec. 2022	Frame, Pin table and Pinout modification	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.